RENESAS

HVC202A

Variable Capacitance Diode for UHF/VHF tuner

REJ03G0095-0200Z (Previous: ADE-208-405A) Rev.2.00 Sep.23.2003

Features

- Low series resistance and good C-V linearity.
- Ultra small Flat Package (UFP) is suitable for surface mount design.

Ordering Information			
Type No.	Laser Mark	Package Code	
HVC202A	Q	UFP	
Pin Arrangement	20,0	0	
	Cathode mark	1. Cathode 2. Anode	
		0,0	



Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Item	Symbol	Value	Unit
Reverse voltage	V _R	34	V
Junction temperature	Tj	125	°C
Storage temperature	Tstg	–55 to +125	°C

Electrical Characteristics

 $(Ta = 25^{\circ}C)$

Item	Symbol	Min	Тур	Мах	Unit	Test Condition
Reverse current	I _{R1}	_	-	10	nA	V _R = 32 V
	I _{R2}	—	-	100	_	V _R = 32 V, Ta = 60°C
Capacitance	C ₂	14.11	- (16.47	pF	$V_{_{\rm R}} = 2 \text{ V}, \text{ f} = 1 \text{ MHz}$
	C ₂₅	2.06	—	2.35		V _R = 25 V, f = 1 MHz
Capacitance ratio	n	6.20	5	_		C ₂ /C ₂₅
Series resistance	r _s	_		0.57	Ω	V _R = 5 V, f = 470 MHz
Matching error	$\Delta C/C *^1$	_	_	2.00	%	$V_{\rm R} = 2$ to 25 V, f = 1 MHz

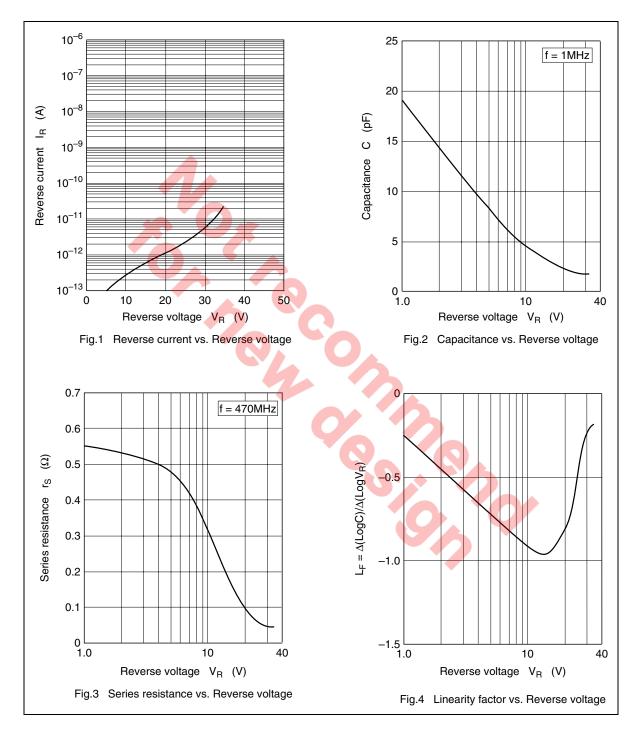
Note: 1. C.C system (Continuous Connected taping system) enable to make any 10 pcs of $\Delta C/C$ continuous in a reel, expect extention to another group. յսբ. Calculate Matching Error,

$$\Delta C/C = \frac{(Cmax - Cmin)}{Cmin} \times 100 \ (\%)$$



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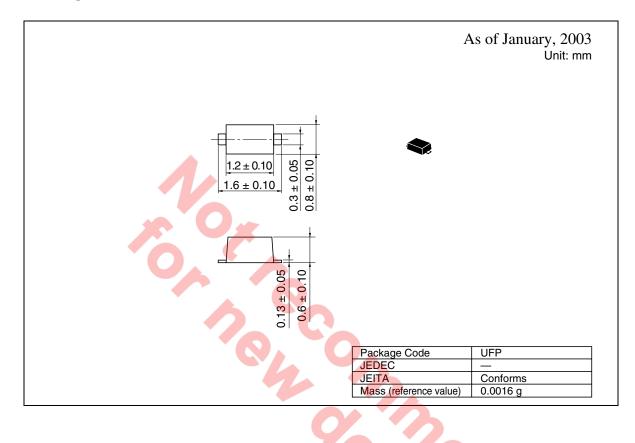
Main Characteristic



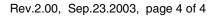


HVC202A

Package Dimensions



0.9





Renesas Technology Corp., Sales Strategic Planning Div. Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan

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RENESAS SALES OFFICES

Renesas Technology America, Inc. 450 Holger Way, San Jose, CA 95134-1368, U.S.A Tel: <1> (408) 382-7500 Fax: <1> (408) 382-7501

Renesas Technology Europe Limited.

Dukes Meadow, Millboard Road, Bourne End, Buckinghamshire, SL8 5FH, United Kingdom Tel: <44> (1628) 585 100, Fax: <44> (1628) 585 900

Renesas Technology Europe GmbH Dornacher Str. 3, D-85622 Feldkirchen, Germany Tel: <49> (89) 380 70 0, Fax: <49> (89) 929 30 11

Renesas Technology Hong Kong Ltd. 7/F., North Tower, World Finance Centre, Harbour City, Canton Road, Hong Kong Tel: <852> 2265-6688, Fax: <852> 2375-6836

Renesas Technology Taiwan Co., Ltd. FL 10, #99, Fu-Hsing N. Rd., Taipei, Taiwan Tel: <886> (2) 2715-2888, Fax: <886> (2) 2713-2999

Renesas Technology (Shanghai) Co., Ltd.

26/F., Ruijin Building, No.205 Maoming Road (S), Shanghai 200020, China Tel: <86> (21) 6472-1001, Fax: <86> (21) 6415-2952

Renesas Technology Singapore Pte. Ltd. 1, Harbour Front Avenue, #06-10, Keppel Bay Tower, Singapore 098632 Tel: <65> 6213-0200, Fax: <65> 6278-8001

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